INTELLIGENCE TO SHAPE YOUR TOMORROW

Generative AI: Memory Market Impacts

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AI DEFINITIONS

- The main goal of AI is for an artificial system to be autonomous. For that, understanding the environment and navigating through it make up a large part of the research.
- Machine learning (ML) is one of the most important fields of AI. The key idea behind ML is teaching an algorithm how to solve a problem by showing it examples of the solution without formally explaining how to reach it.
- An (artificial) neural network is a network of simple elements called neurons and is one of the ML methods. Neurons are organized in layers, and when a network has several layers, it is called a deep neural network (DNN). We are talking about deep learning (DL) when machine learning principles are applied to DNN.
- Transformer neural networks have a DNN architecture using a self-attention mechanism. These are designed to process sequential input. It comprises two main elements: an encoder network and a decoder network.
- Large language models (LLMs) are networks with a transformer architecture and a large number of parameters, trained on large quantities of unlabeled text using self-supervised and semi-supervised learning. They enable many NLP applications such as generating, summarizing, and translating texts.
- Generative AI is a type of AI capable of generating text, images, video, audio, code, 3D models, etc., in response to prompts. Generative AI can create new and original content on demand.





PROCESSORS FOR ARTIFICIAL INTELLIGENCE – TRAINING FOCUS

Processor requirements* by AI model



DATACENTER AI PROCESSORS

Computing performance for artificial intelligence in datacenter

1000 •Nvidia B200 AMD MI300X Intel Gaudi Nvidia B100 AMD MI25 Nvidia H100 SXM 80GB A100 80C OPSIN' Tesla AMD MI2 Google TPU v2 Google TPU v3 Thermal Design Power (W) Google TPU v4 Baidu Kunlun I Google TPU v5p 0 Baidu Kunlun II 100 Nvidia L4 100 TELOPSIN ~~ 10 10 1000 100 10000 Computing Performance FP16 (TFLOPS) Non-exhaustive list F the Future of Memory and Storage

Performance per watt (TFLOPS/W)



DATACENTER AI PROCESSORS Memory for artificial intelligence

A GPU's memory capacity is essential for artificial intelligence. Memory has two main purposes:

- 1. Store the AI model (~parameters)
- 2. Store the KV cache, i.e., the matrices K and V used for calculating attention in generative ai.



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Memory per chip (GB)

In the inference phase (the model has been trained before) it is possible to have several users simultaneously. However, this will depend on several parameters, such as the capacity of the HBM memory.

Average (x)PU memory usage for generative AI for one user



Parameters KV cache for batch size = 1 Others





Note: these are theoretical results obtained using the Llama2 model. These values may differ in real-life conditions.

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DATACENTER - GPU AND AI ASIC FORECAST

(\$B)

Revenue forecast by type of processor, in \$B

- The massive growth that the datacenter GPU and AI ASIC market experienced in 2023 (167% YoY) is expected to continue in 2024 before stabilizing in the year following. We expect this stabilization since the number of companies able to massively buy GPUs and AI ASIC is limited, and because the lifecycle of these components is also growing on average. However, we don't expect a revenue decrease after this big growth, since AI progress is very fast, the model size is still expanding, and the corresponding applications are far from all being discovered. We expect that the ratio of GPU and AI ASIC used for AI inferences will grow in the coming years.
- The total market is expected to reach more than \$150B in 2025 and more than \$230B in 2029. It represents a CAGR₂₃₋₂₉ of 29%.





AI DEMAND IS OUTPACING THE OVERALL SERVER MARKET



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HBM: MORE COMPLICATED PRODUCTION EFFORT





Compounding yield impact on cost per Gb



HBM requires almost 3X as many wafer starts for same bit output as DDR5

- Die size, TSV area, TSV process yield
- Packaging yield and compounding yield effect

Small variations in yield can greatly distort the product cost

- In an 8-high package, 1 ppt of worse yield results in 9% higher cost/bit
- At 16-high, 1 ppt of worse yield results in 18% higher cost/bit



FROM BASIC AI FEATURE TO GEN AI



MARKET TRENDS – BIT-DEMAND GROWTH DRIVEN BY AI

DRAM requirements for AI-model training and inference



PC AND SMARTPHONE DEMAND SUMMARY



PC DRAM DENSITY MIX (% of units)





SMARTPHONE SHIPMENTS (m)

SMARTPHONE DENSITY MIX (% of units)





DRAM SEGMENT BIT DEMAND



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